

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application No. : 10/549,440 Confirmation No. 5587
Applicant : Takeo Okabe
371 Filed : September 16, 2005
Art Unit : 1793
Examiner : Sikyin Ip
Customer No. : 00270
Title : COPPER ALLOY SPUTTERING TARGET, PROCESS FOR
PRODUCING THE SAME AND SEMICONDUCTOR
ELEMENT WIRING

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

AMENDMENT

Sir:

This is an Amendment submitted in timely response to a non-final Office Action dated July 8, 2009. Kindly amend the application as set forth below.

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks/Arguments begin on page 6 of this paper.